IRF640, SiHF640

Vishay Siliconix

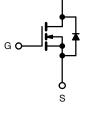
RoHS



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	200				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.18			
Q _g (Max.) (nC)	70				
Q _{gs} (nC)	13				
Q _{gd} (nC)	39				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF640PbF
	SiHF640-E3
SnPb	IRF640
	SiHF640

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	200	v	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V =======V	T _C = 25 °C T _C = 100 °C		18		
	V _{GS} at 10 V	T _C = 100 °C	ID	11	А	
Pulsed Drain Current ^a			I _{DM}	72		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	580	mJ	
Repetitive Avalanche Current ^a			I _{AR}	18	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation	T _C = 25 °C		PD	125	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150		
Soldering Recommendations (Peak temperature) ^d	for	10 s	-	300	°C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.7 mH, $R_g = 25 \Omega$, $I_{AS} = 18$ A (see fig. 12). c. $I_{SD} \le 18$ A, dI/dt ≤ 150 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C. d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.	MAX.	MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62					
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-		°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 250 μΑ	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.29	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	′ _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	_S = ± 20 V	-	-	± 100	nA
		V _{DS} = 2	00 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 160 V, \	/ _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A ^b	-	-	0.18	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 11 A ^b	6.7	-	-	S
Dynamic		•			•		
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	1300	-	pF
Output Capacitance	C _{oss}			-	430	-	
Reverse Transfer Capacitance	C _{rss}			-	130	-	
Total Gate Charge	Qg			-	-	70	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 18 A, V _{DS} =160 V, see fig. 6 and 13 ^b	-	-	13	
Gate-Drain Charge	Q _{gd}		see lig. 0 and 15	-	-	39	
Turn-On Delay Time	t _{d(on)}		•	-	14	-	-
Rise Time	t _r	V _{DD} = 1	00 V, I _D = 18 A,	-	51	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$, $R_D = 5.4 \Omega$, see fig. 10 ^b		-	45	-	ns
Fall Time	t _f			-	36	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L _S			-	7.5	-	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.5	-	3.6	Ω
Drain-Source Body Diode Characteristic	s			•	•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbo showing the		-	-	18	•
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	72	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 18 A, V _{GS} = 0 V ^b		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 18 \text{ A}, dl/dt = 100 \text{ A/}\mu\text{s}^{\text{b}}$		-	300	610	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.4	7.1	μC
Forward Turn-On Time	t _{on}	Intrinsic turn	-on time is negligible (turn	- on is do	minated b	$_{\rm by L_S}$ and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

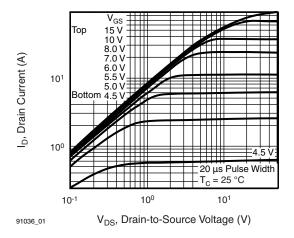
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





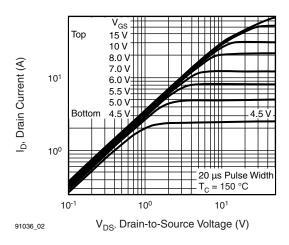


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^\circ C$

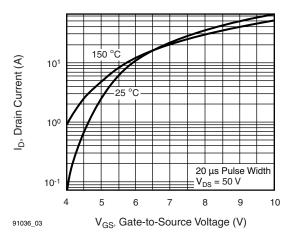


Fig. 3 - Typical Transfer Characteristics

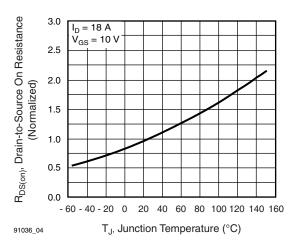


Fig. 4 - Normalized On-Resistance vs. Temperature

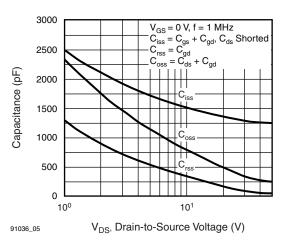


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

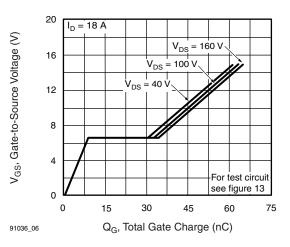


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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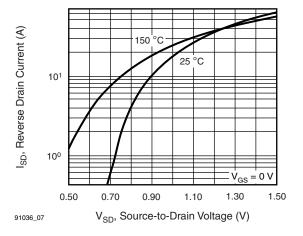


Fig. 7 - Typical Source-Drain Diode Forward Voltage

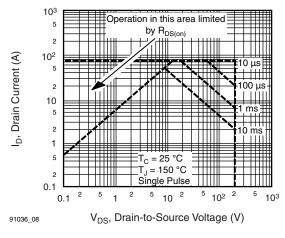


Fig. 8 - Maximum Safe Operating Area

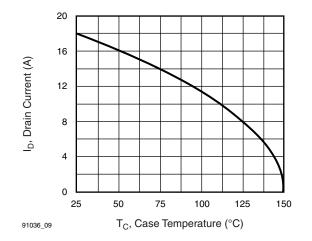


Fig. 9 - Maximum Drain Current vs. Case Temperature

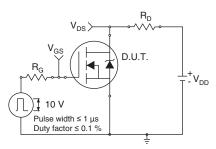


Fig. 10a - Switching Time Test Circuit

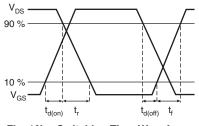
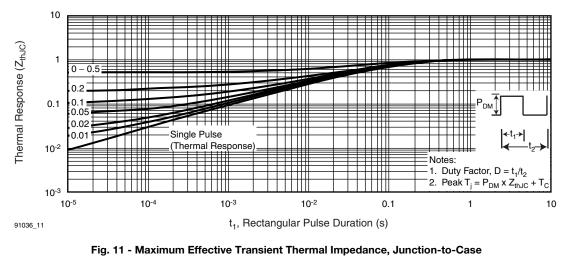


Fig. 10b - Switching Time Waveforms



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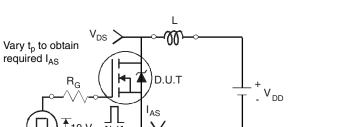
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0.01 Ω

Fig. 12a - Unclamped Inductive Test Circuit

tp

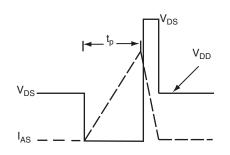


Fig. 12b - Unclamped Inductive Waveforms

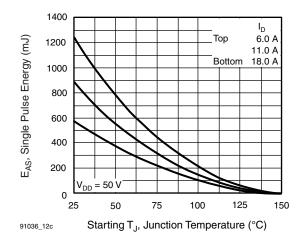


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

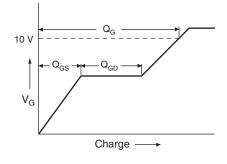


Fig. 13a - Basic Gate Charge Waveform

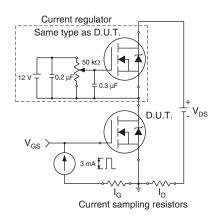


Fig. 13b - Gate Charge Test Circuit

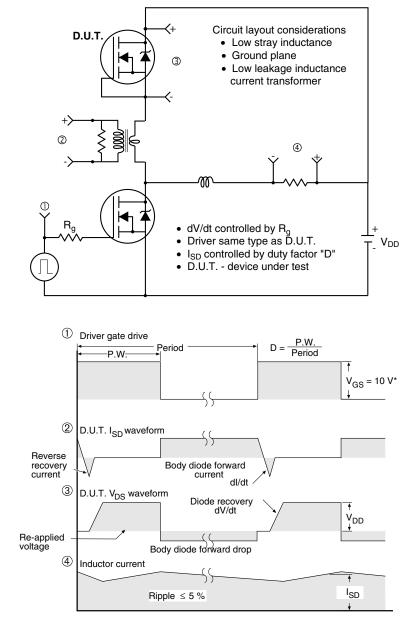
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Peak Diode Recovery dV/dt Test Circuit

* $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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